

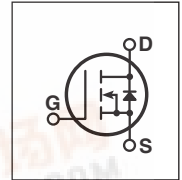
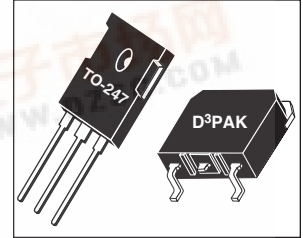


**600V 20A 0.220Ω**  
**APT20N60BCF APT20N60SCF**  
**APT20N60BCFG\* APT20N60SCFG\***

\*G Denotes RoHS Compliant, Pb Free Terminal Finish.



**Super Junction FREDFET**



- Ultra Low  $R_{DS(ON)}$
- Low Miller Capacitance
- Ultra Low Gate Charge,  $Q_g$
- Avalanche Energy Rated
- Extreme  $dv/dt$  Rated
- Intrinsic Fast-Recovery Body Diode
- Extreme Low Reverse Recovery Charge
- Ideal For ZVS Applications
- Popular TO-247 or Surface Mount D<sup>3</sup> Package

**MAXIMUM RATINGS**

All Ratings:  $T_C = 25^\circ C$  unless otherwise specified.

Symbol	Parameter	APT20N60BCF(G)_SCF(G)	UNIT
$V_{DSS}$	Drain-Source Voltage	600	Volts
$I_D$	Continuous Drain Current @ $T_C = 25^\circ C$	20	Amps
	Continuous Drain Current @ $T_C = 100^\circ C$	13	
$I_{DM}$	Pulsed Drain Current <sup>①</sup>	60	
$V_{GS}$	Gate-Source Voltage Continuous	±30	Volts
$P_D$	Total Power Dissipation @ $T_C = 25^\circ C$	208	Watts
	Linear Derating Factor	1.67	W/°C
$T_J, T_{STG}$	Operating and Storage Junction Temperature Range	-55 to 150	°C
$T_L$	Lead Temperature: 0.063" from Case for 10 Sec.	260	
$dv/dt$	Drain-Source Voltage slope ( $V_{DS} = 480V, I_D = 20A, T_J = 125^\circ C$ )	80	V/ns
$I_{AR}$	Avalanche Current <sup>⑦</sup>	20	Amps
$E_{AR}$	Repetitive Avalanche Energy <sup>⑦</sup>	1	mJ
$E_{AS}$	Single Pulse Avalanche Energy <sup>④</sup>	690	

**STATIC ELECTRICAL CHARACTERISTICS**

Symbol	Characteristic / Test Conditions	MIN	TYP	MAX	UNIT
$BV_{DSS}$	Drain-Source Breakdown Voltage ( $V_{GS} = 0V, I_D = 250\mu A$ )	600			Volts
$R_{DS(on)}$	Drain-Source On-State Resistance <sup>②</sup> ( $V_{GS} = 10V, I_D = 13A$ )			0.220	Ohms
$I_{DSS}$	Zero Gate Voltage Drain Current ( $V_{DS} = 600V, V_{GS} = 0V$ )			2.1	μA
	Zero Gate Voltage Drain Current ( $V_{DS} = 600V, V_{GS} = 0V, T_C = 150^\circ C$ )			1700	
$I_{GSS}$	Gate-Source Leakage Current ( $V_{GS} = \pm 20V, V_{DS} = 0V$ )			±100	nA
$V_{GS(th)}$	Gate Threshold Voltage ( $V_{DS} = V_{GS}, I_D = 1mA$ )	3	4	5	Volts

CAUTION: These Devices are Sensitive to Electrostatic Discharge. Proper Handling Procedures Should Be Followed.

APT Website - <http://www.advancedpower.com>

"COOLMOS™" comprise a new family of transistors developed by Infineon Technologies AG. "COOLMOS" is a trade-

**DYNAMIC CHARACTERISTICS**

**APT20N60BCF(G)\_SCF(G)**

Symbol	Characteristic	Test Conditions	MIN	TYP	MAX	UNIT
C <sub>iss</sub>	Input Capacitance	V <sub>GS</sub> = 0V V <sub>DS</sub> = 25V f = 1 MHz		2520		pF
C <sub>oss</sub>	Output Capacitance			670		
C <sub>rss</sub>	Reverse Transfer Capacitance			40		
Q <sub>g</sub>	Total Gate Charge <sup>③</sup>	V <sub>GS</sub> = 10V V <sub>DD</sub> = 300V I <sub>D</sub> = 20A @ 25°C		95		nC
Q <sub>gs</sub>	Gate-Source Charge			18		
Q <sub>gd</sub>	Gate-Drain ("Miller") Charge			55		
t <sub>d(on)</sub>	Turn-on Delay Time	<b>RESISTIVE SWITCHING</b> V <sub>GS</sub> = 15V V <sub>DD</sub> = 380V I <sub>D</sub> = 20A @ 25°C R <sub>G</sub> = 3.6Ω		12		ns
t <sub>r</sub>	Rise Time			15		
t <sub>d(off)</sub>	Turn-off Delay Time			60		
t <sub>f</sub>	Fall Time			6.4		
E <sub>on</sub>	Turn-on Switching Energy <sup>⑥</sup>	<b>INDUCTIVE SWITCHING @ 25°C</b> V <sub>DD</sub> = 400V, V <sub>GS</sub> = 15V I <sub>D</sub> = 20A, R <sub>G</sub> = 5Ω		180		μJ
E <sub>off</sub>	Turn-off Switching Energy			60		
E <sub>on</sub>	Turn-on Switching Energy <sup>⑥</sup>	<b>INDUCTIVE SWITCHING @ 125°C</b> V <sub>DD</sub> = 400V, V <sub>GS</sub> = 15V I <sub>D</sub> = 20A, R <sub>G</sub> = 5Ω		315		
E <sub>off</sub>	Turn-off Switching Energy			80		

**SOURCE-DRAIN DIODE RATINGS AND CHARACTERISTICS**

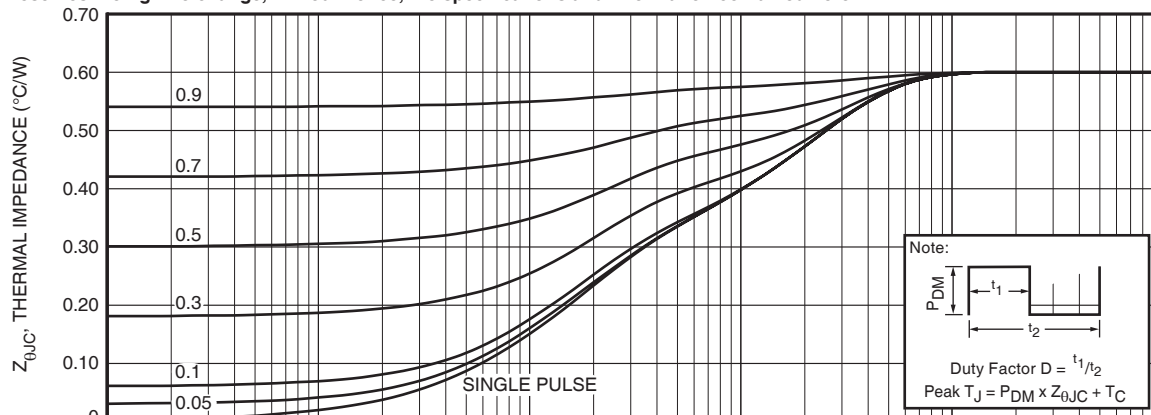
Symbol	Characteristic / Test Conditions	MIN	TYP	MAX	UNIT
I <sub>S</sub>	Continuous Source Current (Body Diode)			20	Amps
I <sub>SM</sub>	Pulsed Source Current <sup>①</sup> (Body Diode)			60	
V <sub>SD</sub>	Diode Forward Voltage <sup>②</sup> (V <sub>GS</sub> = 0V, I <sub>S</sub> = -20A)			1.2	Volts
dv/dt	Peak Diode Recovery <sup>⑤</sup> dv/dt			40	V/ns
t <sub>rr</sub>	Reverse Recovery Time (I <sub>S</sub> = -20A, di/dt = 100A/μs)	T <sub>J</sub> = 25°C		180	ns
		T <sub>J</sub> = 125°C		260	
Q <sub>rr</sub>	Reverse Recovery Charge (I <sub>S</sub> = -20A, di/dt = 100A/μs)	T <sub>J</sub> = 25°C		1.4	μC
		T <sub>J</sub> = 125°C		2.5	
I <sub>RRM</sub>	Peak Recovery Current (I <sub>S</sub> = -20A, di/dt = 100A/μs)	T <sub>J</sub> = 25°C		15	Amps
		T <sub>J</sub> = 125°C		18	

**THERMAL CHARACTERISTICS**

Symbol	Characteristic	MIN	TYP	MAX	UNIT
R <sub>θJC</sub>	Junction to Case			0.60	°C/W
R <sub>θJA</sub>	Junction to Ambient			62	

- ① Repetitive Rating: Pulse width limited by maximum junction temperature
- ② Pulse Test: Pulse width < 380 μs, Duty Cycle < 2%
- ③ See MIL-STD-750 Method 3471
- ④ Starting T<sub>J</sub> = +25°C, L = 13.80mH, R<sub>G</sub> = 25Ω, Peak I<sub>L</sub> = 10A
- ⑤ dv/dt numbers reflect the limitations of the test circuit rather than the device itself. I<sub>S</sub> ≤ -I<sub>D</sub>20A di/dt ≤ 700A/μs V<sub>R</sub> ≤ 480V T<sub>J</sub> ≤ 125°C
- ⑥ E<sub>on</sub> includes diode reverse recovery. See figures 18, 20.
- ⑦ Repetitive avalanche causes additional power losses that can be calculated as P<sub>AV</sub> = E<sub>AR</sub>\*f

APT Reserves the right to change, without notice, the specifications and information contained herein.



# Typical Performance Curves

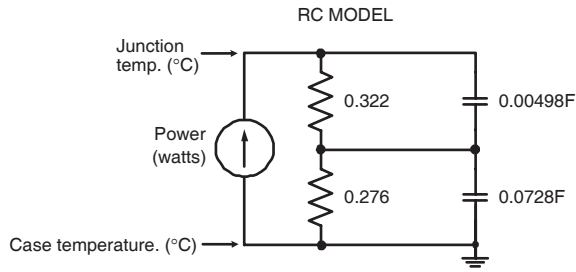


FIGURE 2, TRANSIENT THERMAL IMPEDANCE MODEL

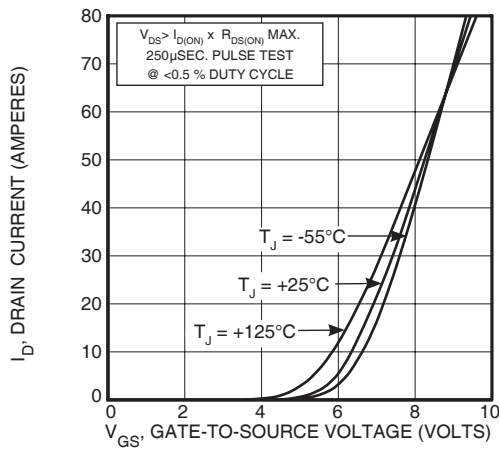


FIGURE 4, TRANSFER CHARACTERISTICS

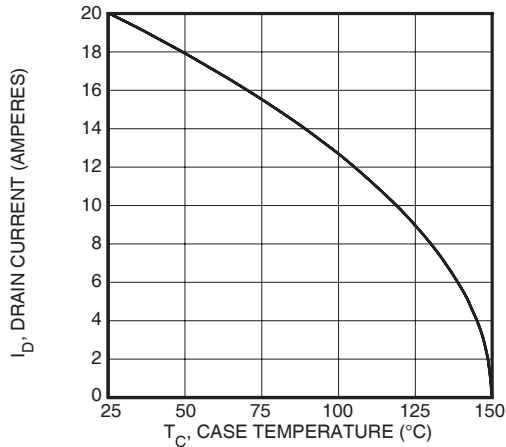


FIGURE 6, MAXIMUM DRAIN CURRENT vs CASE TEMPERATURE

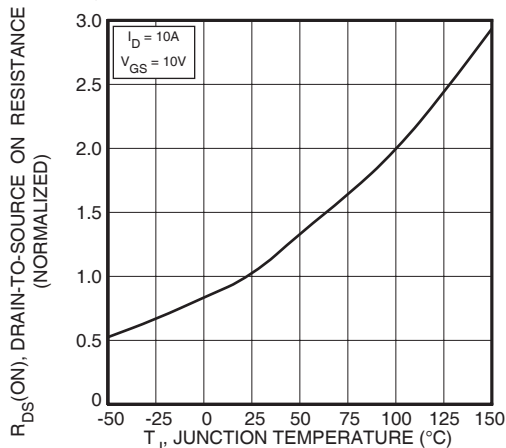


FIGURE 8, ON-RESISTANCE vs. TEMPERATURE

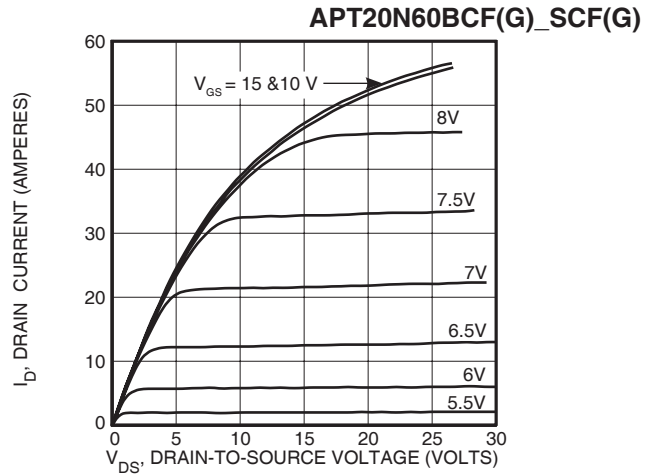


FIGURE 3, LOW VOLTAGE OUTPUT CHARACTERISTICS

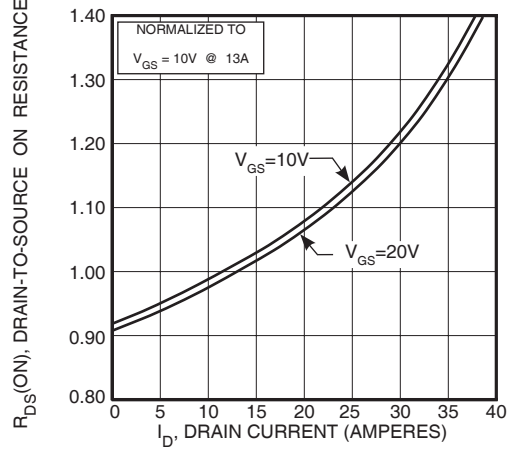


FIGURE 5,  $R_{DS(ON)}$  vs DRAIN CURRENT

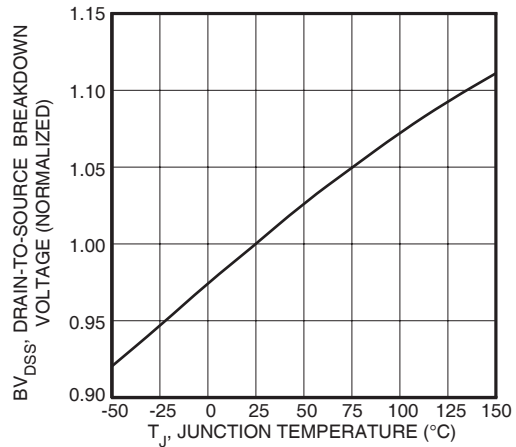


FIGURE 7, BREAKDOWN VOLTAGE vs TEMPERATURE

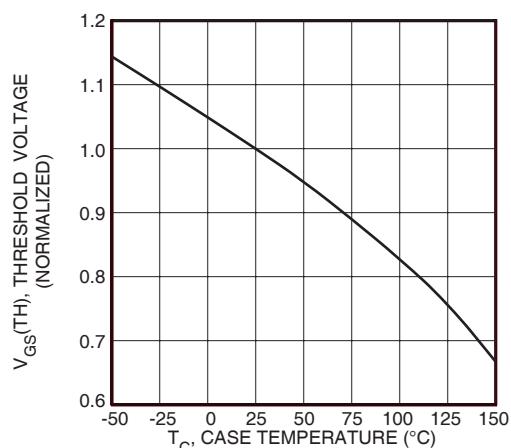


FIGURE 9, THRESHOLD VOLTAGE vs TEMPERATURE

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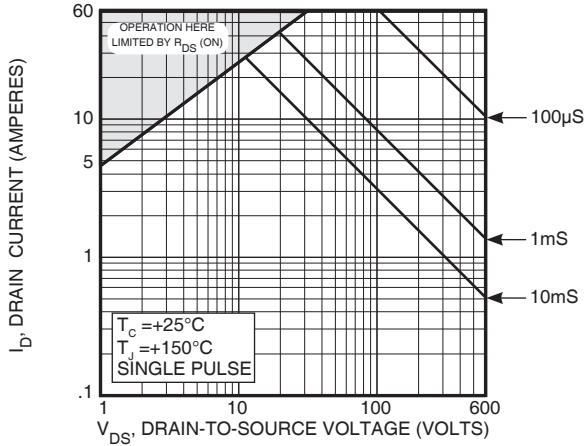


FIGURE 10, MAXIMUM SAFE OPERATING AREA

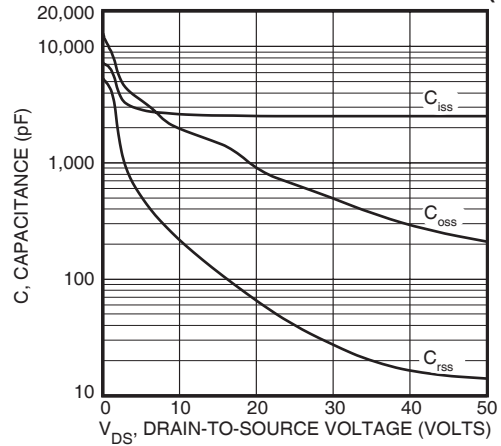


FIGURE 11, CAPACITANCE vs DRAIN-TO-SOURCE VOLTAGE

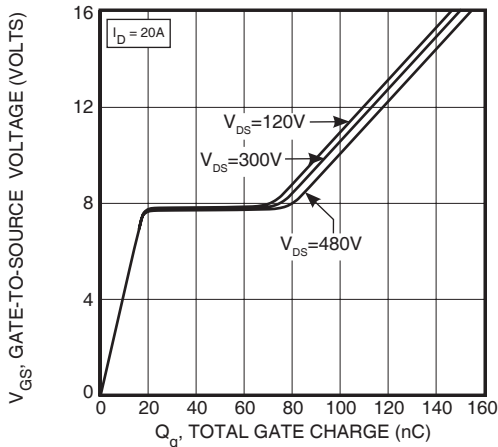


FIGURE 12, GATE CHARGE vs GATE-TO-SOURCE VOLTAGE

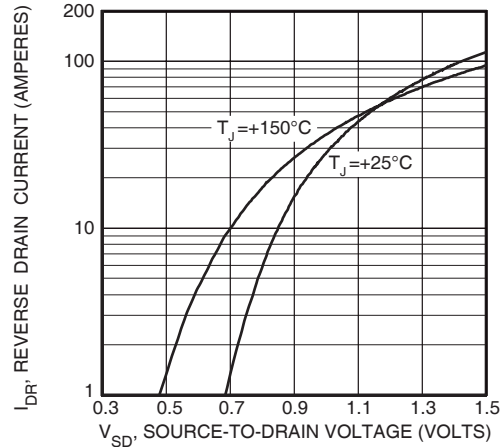


FIGURE 13, SOURCE-DRAIN DIODE FORWARD VOLTAGE

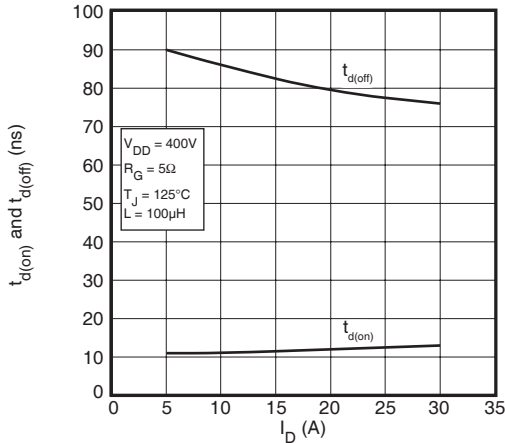


FIGURE 14, DELAY TIMES vs CURRENT

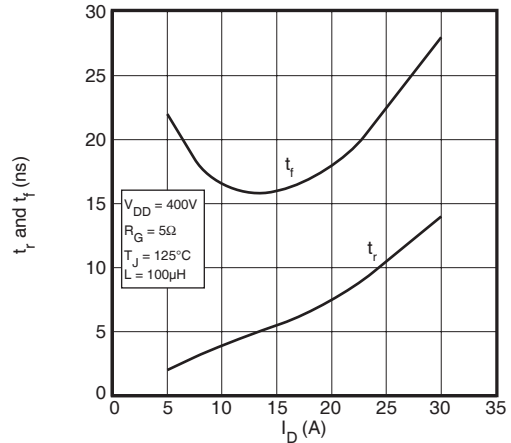


FIGURE 15, RISE AND FALL TIMES vs CURRENT

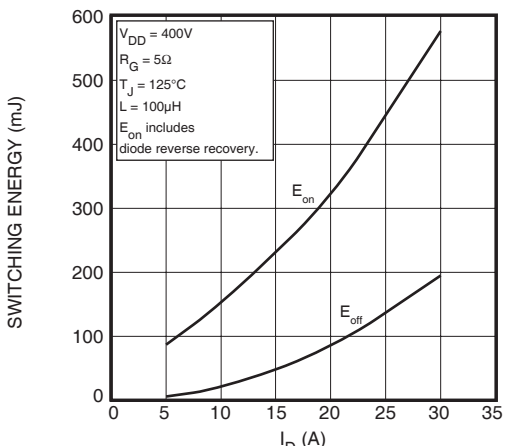


FIGURE 16, SWITCHING ENERGY vs CURRENT

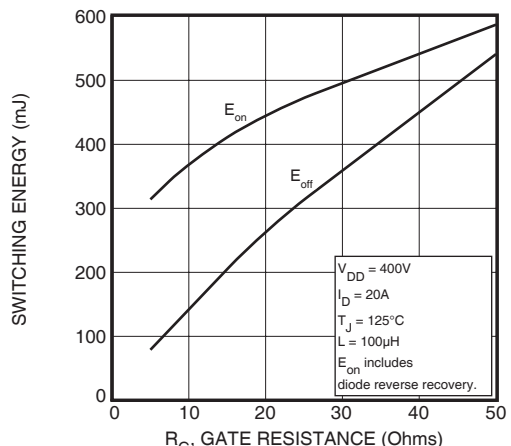


FIGURE 17, SWITCHING ENERGY vs. GATE RESISTANCE

# APT20N60BCF(G)\_SCF(G)

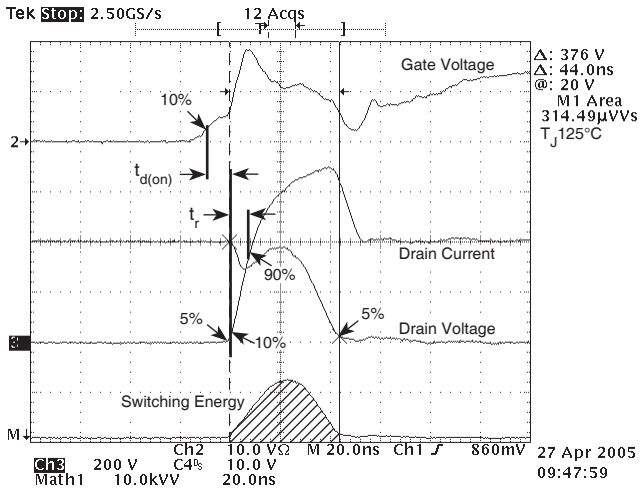


Figure 18, Turn-on Switching Waveforms and Definitions

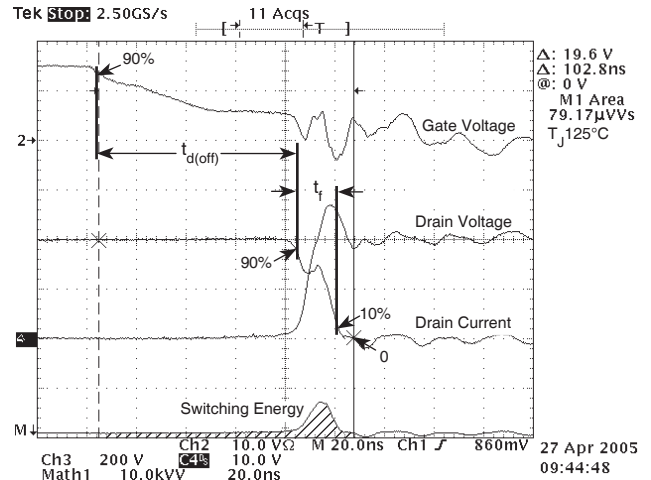


Figure 19, Turn-off Switching Waveforms and Definitions

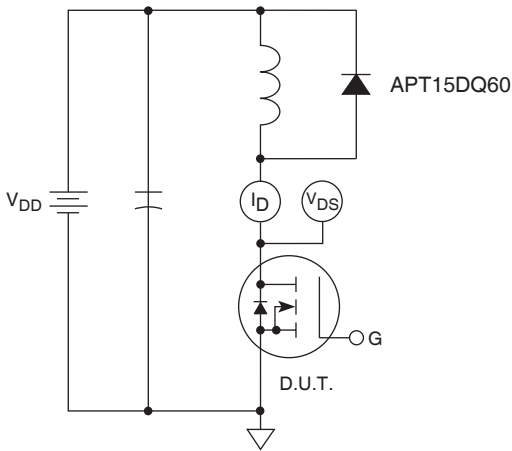
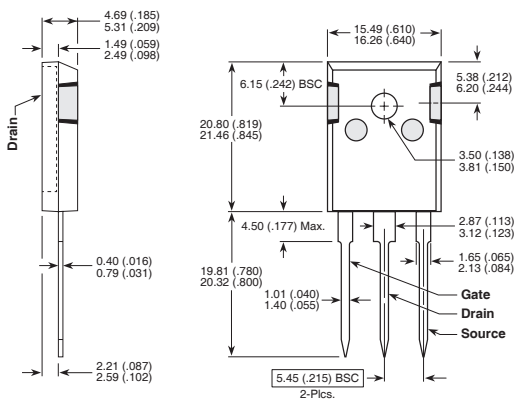


Figure 20, Inductive Switching Test Circuit

## TO-247 Package Outline

e1 SAC: Tin, Silver, Copper



## D<sup>3</sup>PAK Package Outline

e3 100% Sn

